



# The Silicon TPC System

The “final” status report

EUDET Annual meeting  
30 September 2010

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NIKHEF/DESY

# SITPC Tasks:

- ✓ Develop the Timepix chip that allows to measure the 3<sup>rd</sup> coordinate (drift time)
- ✓ Implementation of Timepix together with GEM and Ingrid into diagnostic endplate system:
  - with GEM working (2009), 2x4 Timepix
  - **STOP PRESS: now also with 8x Ingrid working**
- ✓ Performance measurements in test infrastructure at DESY (analysis GEM+Timepix data in progress)
- ✓ Develop simulation framework (and continues)
- ✓ Develop DAQ system and integrate in overall DAQ of EUDET infrastructure (first used in June'09; now also used with EUDET- and ZEUS MVD-telescopes)

Partners: ALU Freiburg, Bonn, CEA Saclay, CERN, NIKHEF

## Final milestone/deliverable has 3 'legs':

- one LP endplate module with triple-GEM (Bonn/Freiburg) read out by system of 2x4 Timepix chips; **operational June'09 in T24; further test on LP maybe later this year**
- one LP endplate module with 8 Ingrids, a Micromegas-like integrated grid (Saclay/Nikhef), on 8 Timepix chips; **operational in gas test box, some HV instabilities in Ar/isoB (95/5); better with He/isoB (80/20); a new set of 8 Ingrids being prepared; test on LP-TPC later this year (?)**
- One (or more) small detector(s) with 'Quad' Ingrids = "traveling infrastructure"; **1 detector with 4 Ingrids ready, RO problems being investigated**

All groups have established contacts with outside institutions for 8" wafer scale post-processing:

- Freiburg Metallforschungszentrum (pixel enlargement)
- IZM Berlin: Ingrid/GEMGrid technology  
(first GEMGrid produced on dummy wafer)
- SMC (Scottish Microelectronics Centre)  
Edinburgh: Ingrid technology
- LAAS (CNRS) Toulouse (max. 6" wafers)

# New stuff presented yesterday

- Impressive account of detailed measurements on avalanche statistics and single electron counting by Michael Lupberger Saclay/Freiburg (Master thesis work)
- NIKHEF 4xTimepix/Ingrid running and combined data taking 1xTimepix + ZEUS MVD telescope running EUDAQ (J.T.)
- Successful running of 8xTimepix/Ingrid in LPTPC module testbox (Paul Colas)

# The “workhorse”

Timepix + Ingrid

or

Timepix + 3x GEM

# Full post-processing of a TimePix

· Timepix chip + SiProt + Ingrid:

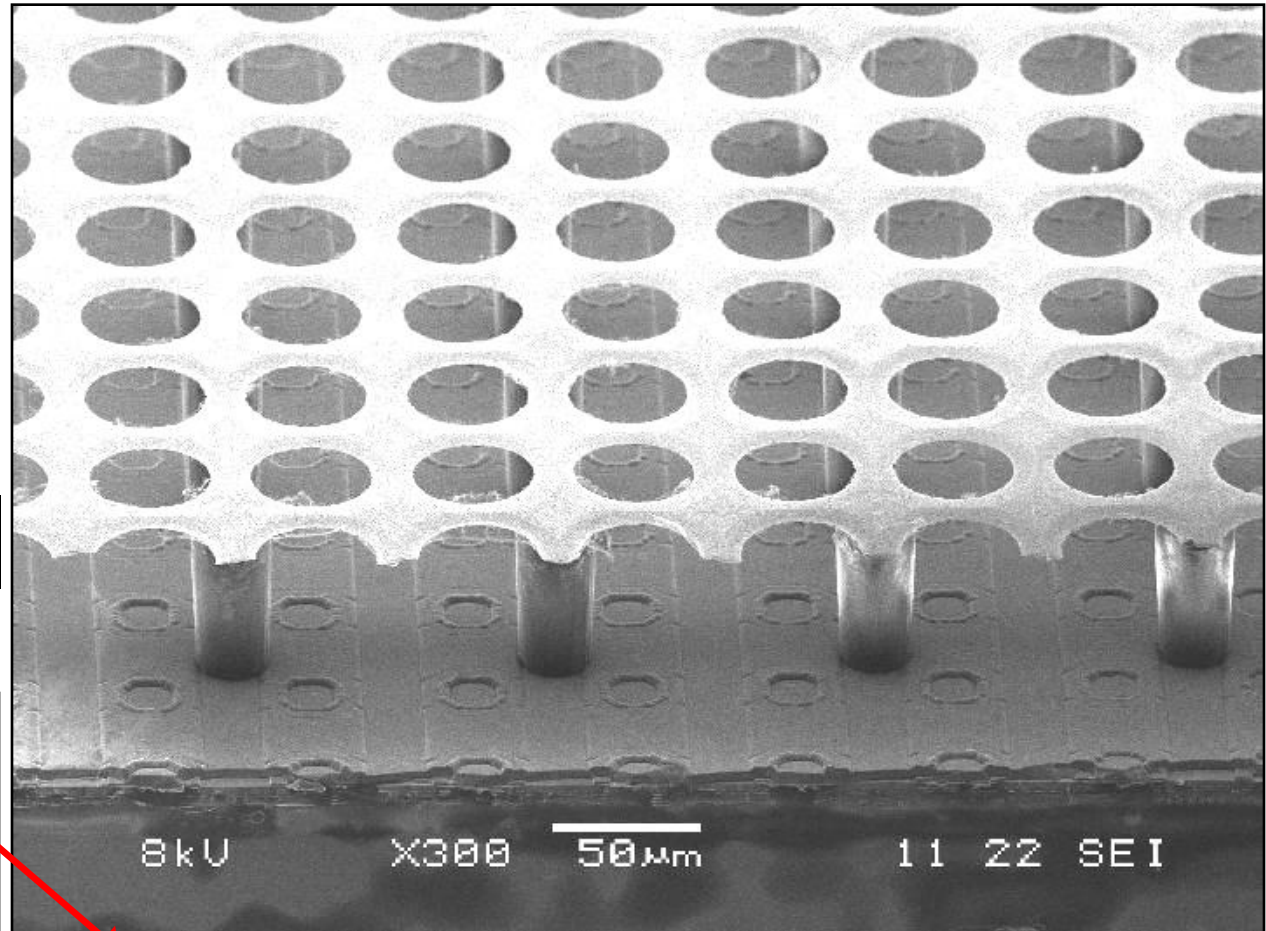
Timepix chip:

- 256x256 pixels
- pixel:  $55 \times 55 \mu\text{m}^2$
- active surface:  $14 \times 14 \text{ mm}^2$

MESA+: Ingrid

IMT Neuchatel:

15 or 20  $\mu\text{m}$  highly resistive aSi:H protection layer



Now also  $\text{Si}_3\text{N}_4$  protection layers ( $7 \mu\text{m}_7$ )

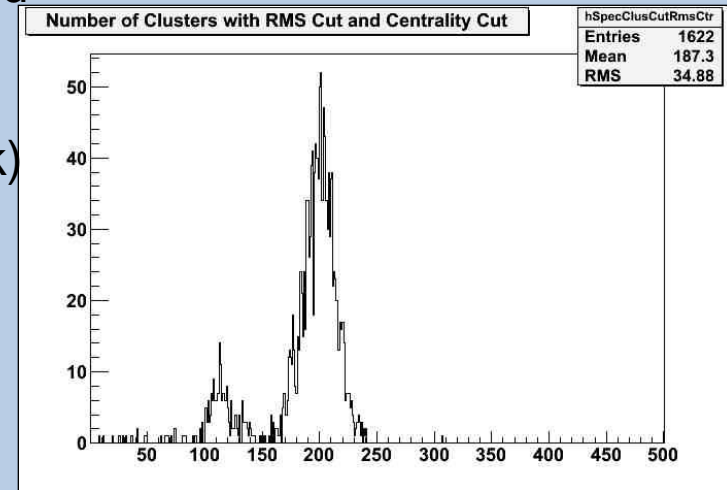
# Fe55 Spectra

## Resolution

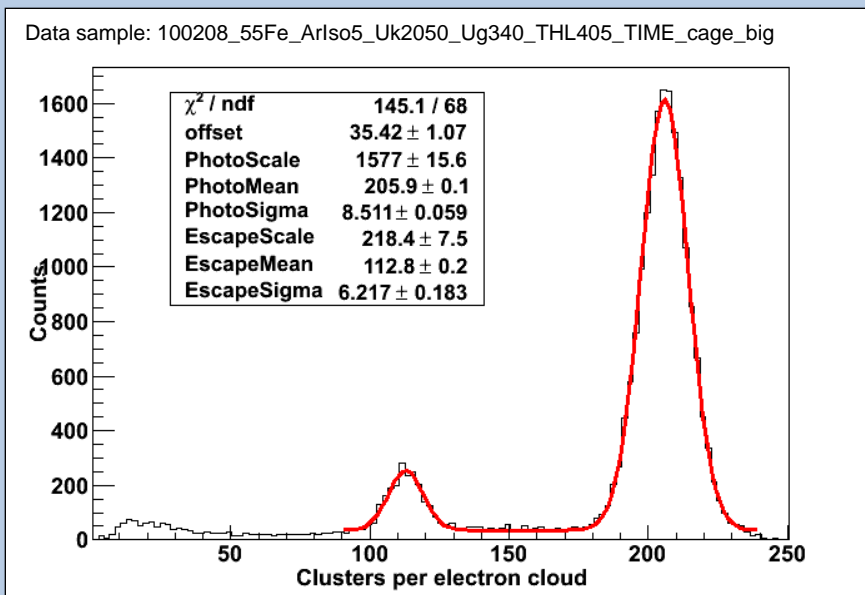
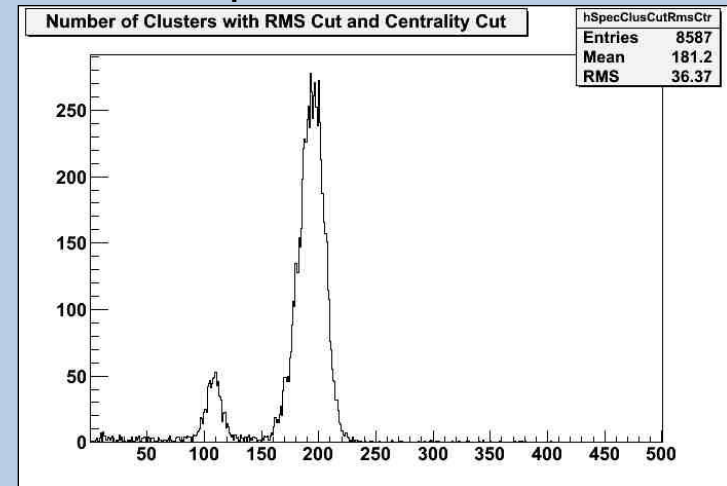
- Count number of hit pixels/clusters per electron cloud
- Chromium foil to absorb  $K_{\beta}$  photons
- long term measurement and hard cut on cloud size
- best resolution achieved: 9,73% FWHM (photo peak)

$$\left(\frac{\sigma_{N_d}}{N_d}\right)^2 = \frac{1}{N_p} \left[ F + \frac{1 - \frac{N_d}{N_p}}{\frac{N_d}{N_p}} \right] [1] \Rightarrow F = 0.26 \text{ (upper limit)}$$

Fe55 spectrum without Cr foil



Fe55 spectrum with Cr foil



[1] Max Chefdeville, Development of Micromegas-like gaseous detectors using a pixel readout chip as collecting anode

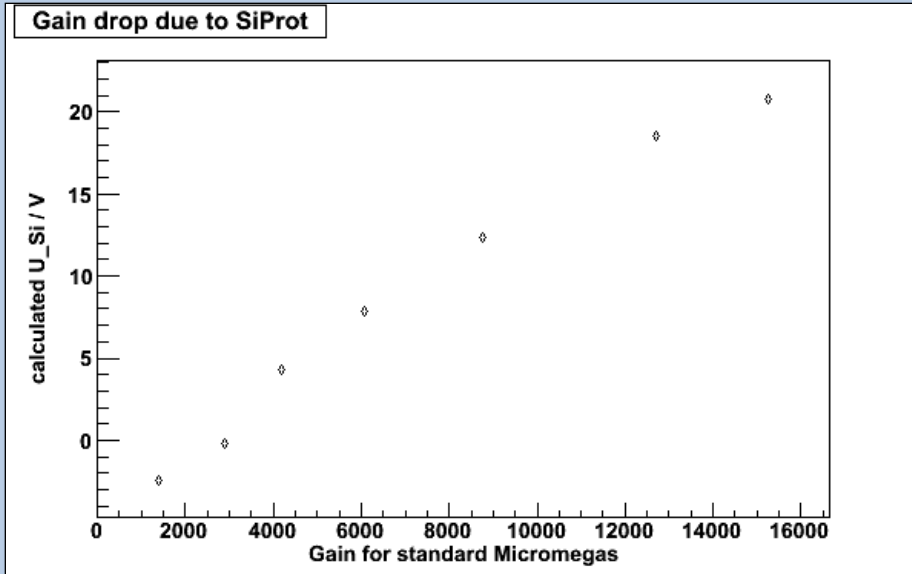


# TimeOverThreshold

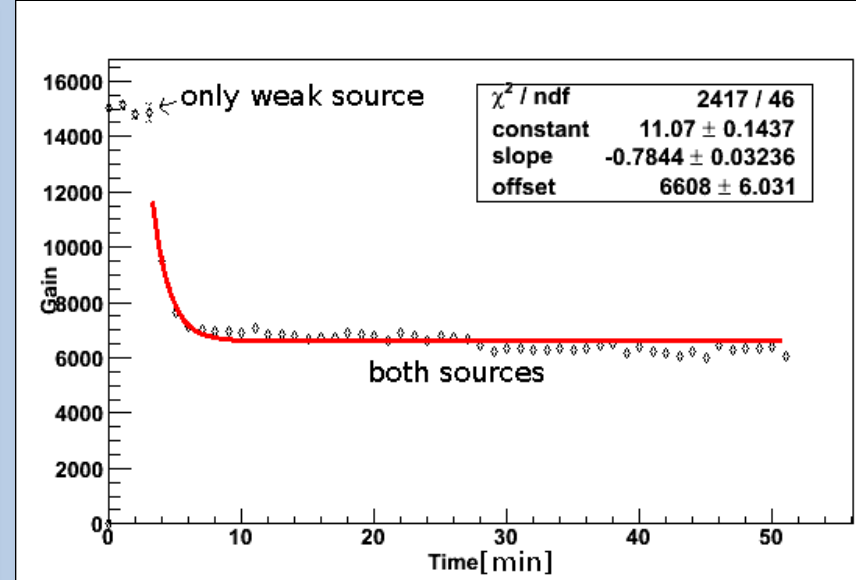
## Influence of SiProt



Calculation of voltage on SiProt surface



Example for gain drop (charging of SiProt)



$$G = \exp(A + B \cdot U)$$

$$\text{mean} = G_{\text{measured}} = \exp(A + B \cdot \Delta U)$$

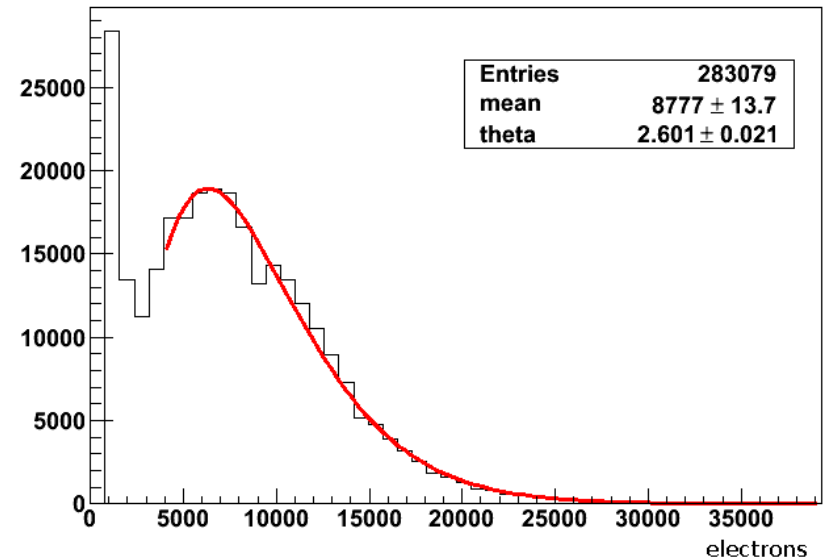
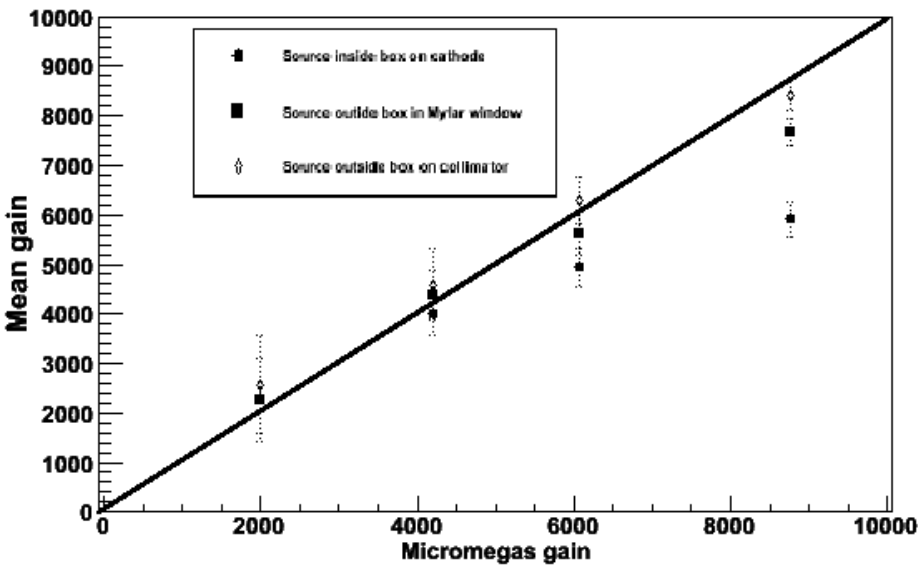
$$\Rightarrow \Delta U = \frac{\ln(\text{mean}) - A}{B}$$

$$U_{\text{Si}} = U - \Delta U \quad U_{\text{Si}} = \frac{W \cdot f \cdot R \cdot G}{B}$$

Put on second, stronger source during measurements:  
Gain drop from 15000 to 6600  
with  $\tau = 1.27 \pm 0.05$  min

# TimeOverThreshold

## Low rate measurements



- Place source further away from detector
- > inside detector (high rate)
- > outside detector box (low rate)
- > outside detector box + collimator (highest rate)

- Measurement at lowest rate
- high gain
- noise visible, as acq. time needs to be longer
- $\Theta = 2.6$

InGrid gain approaches Micromegas gain

# Combined Measurement

## Detection Efficiency



Comparison of theory and measurements assuming Polya distribution  
Combine gain and primary electron measurements

From gain (TOT) measurements: Polya mean = gain

From primary electron (TIME) meas.:  
number of prim. electrons,  
117,9 electrons = 100 % det. Eff.

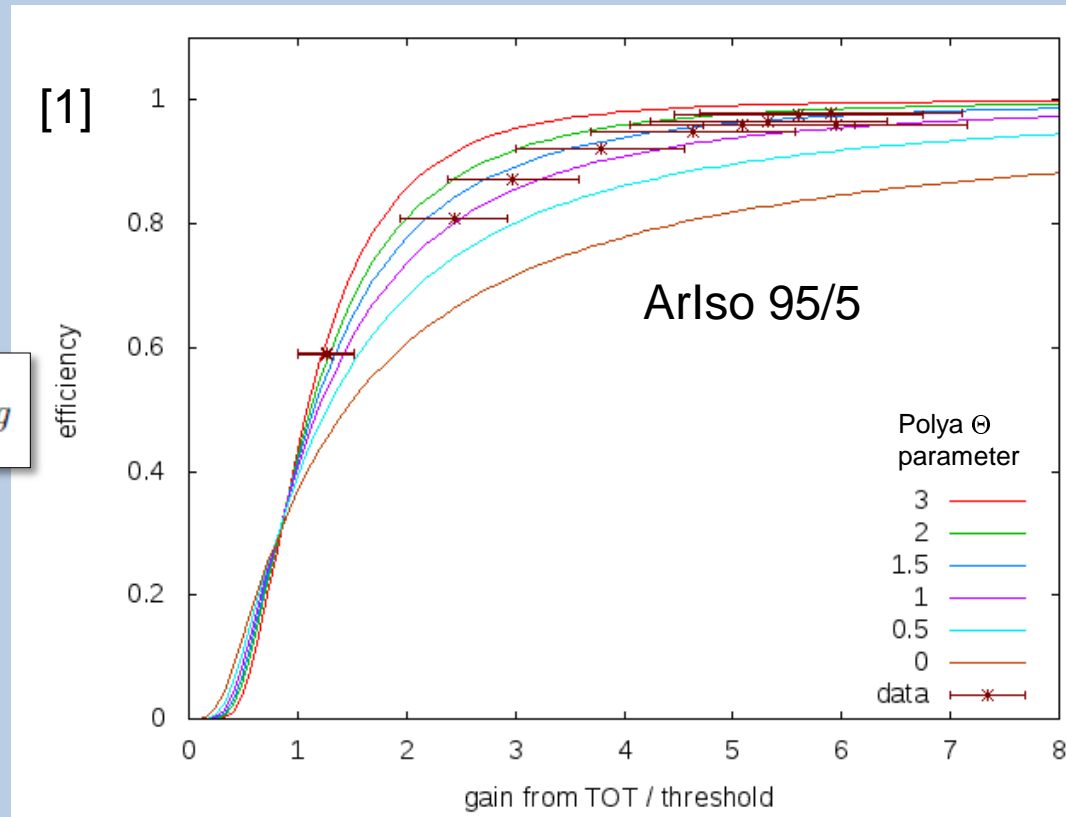
Detection efficiency:

$$\kappa(m, G, t) = \int_t^\infty \frac{m^m}{\Gamma(m)} \frac{1}{G} \left(\frac{g}{G}\right)^{m-1} \exp\left(-m\frac{g}{G}\right) dg$$

$$m = \Theta + 1$$

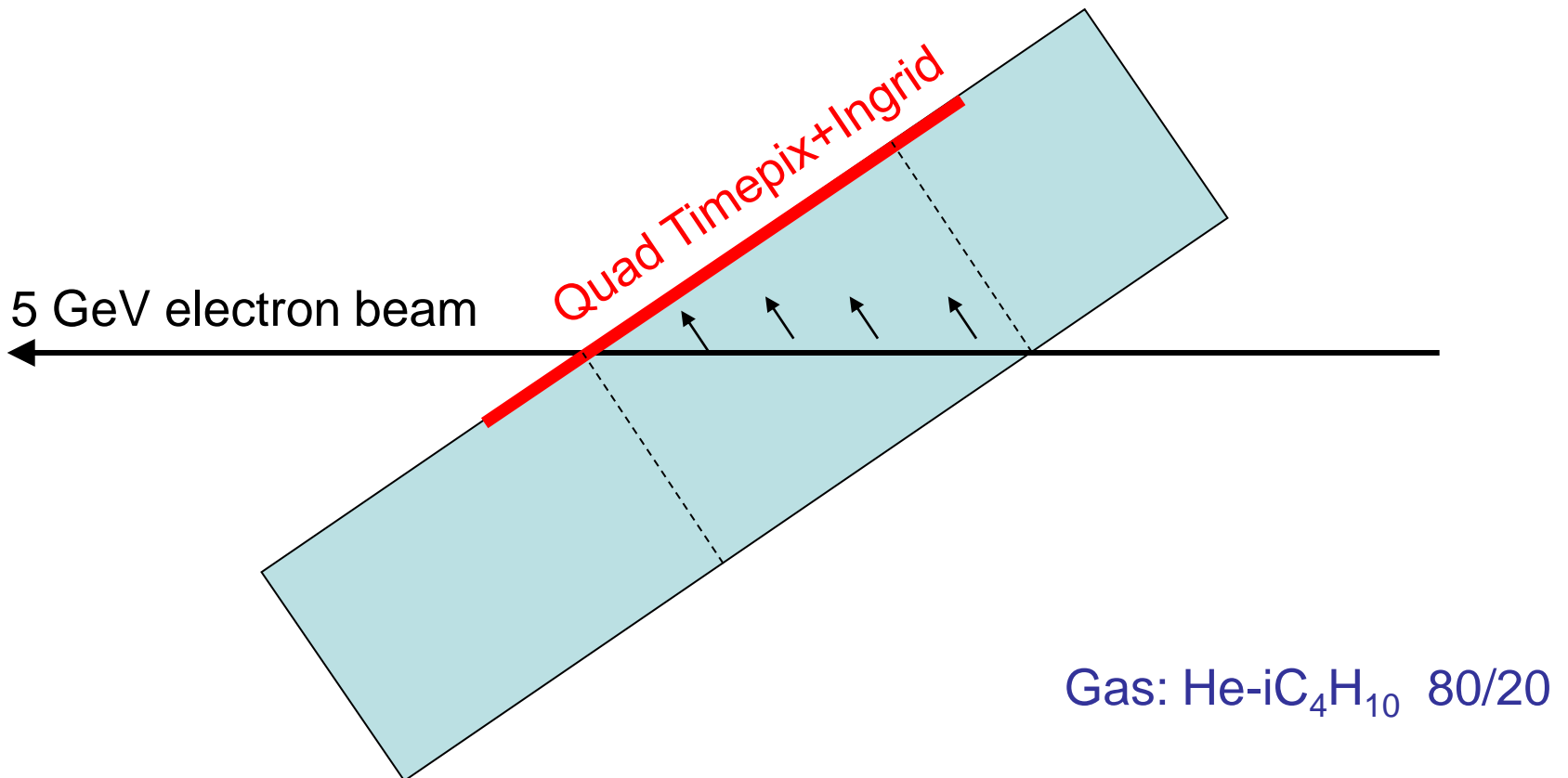
Threshold:  $t = 1150$  electrons

$$\Rightarrow 0.5 < \Theta < 2$$

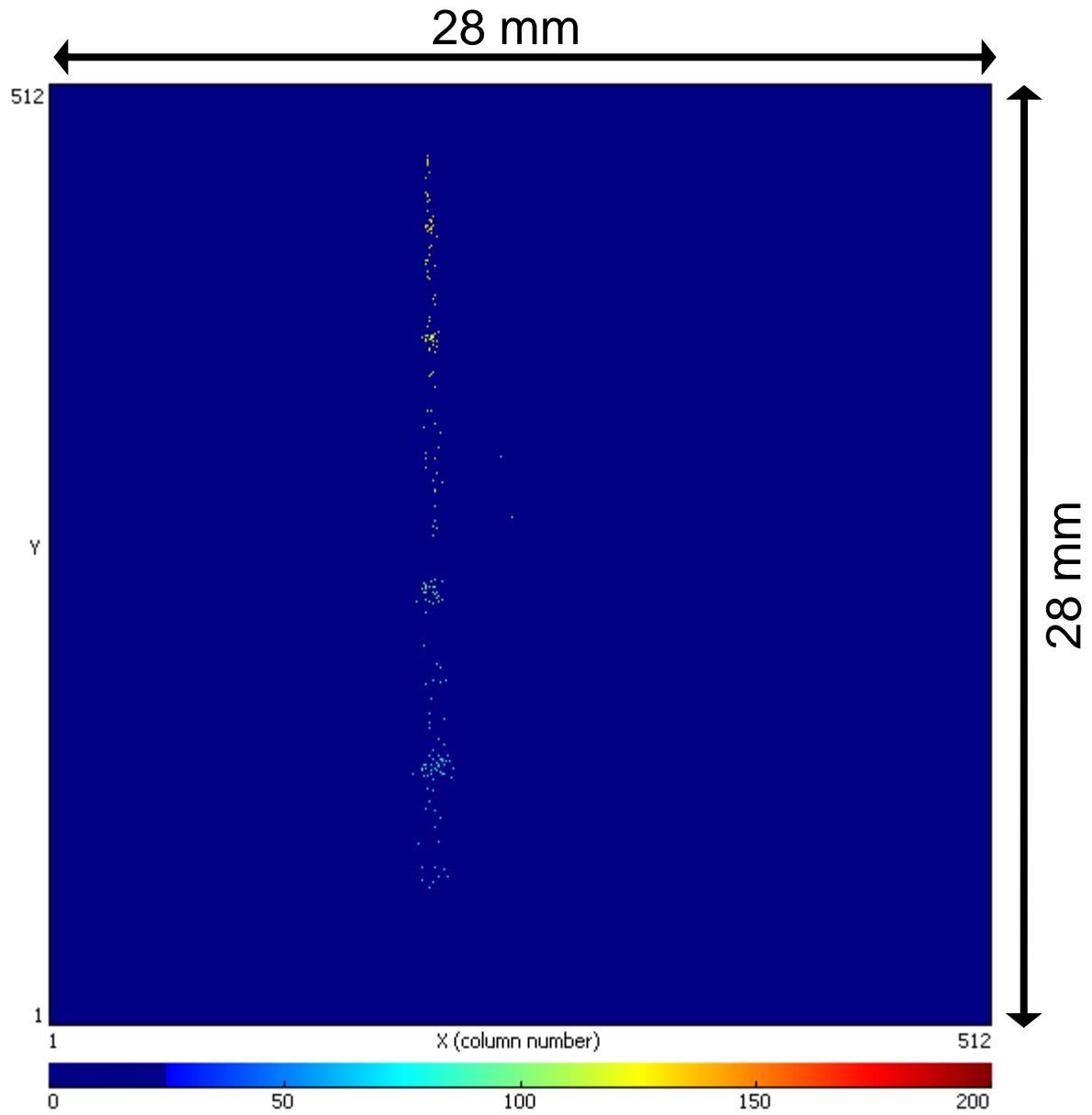


[1] Max Chefdeville, Development of Micromegas-like gaseous detectors using a pixel readout chip as collecting anode

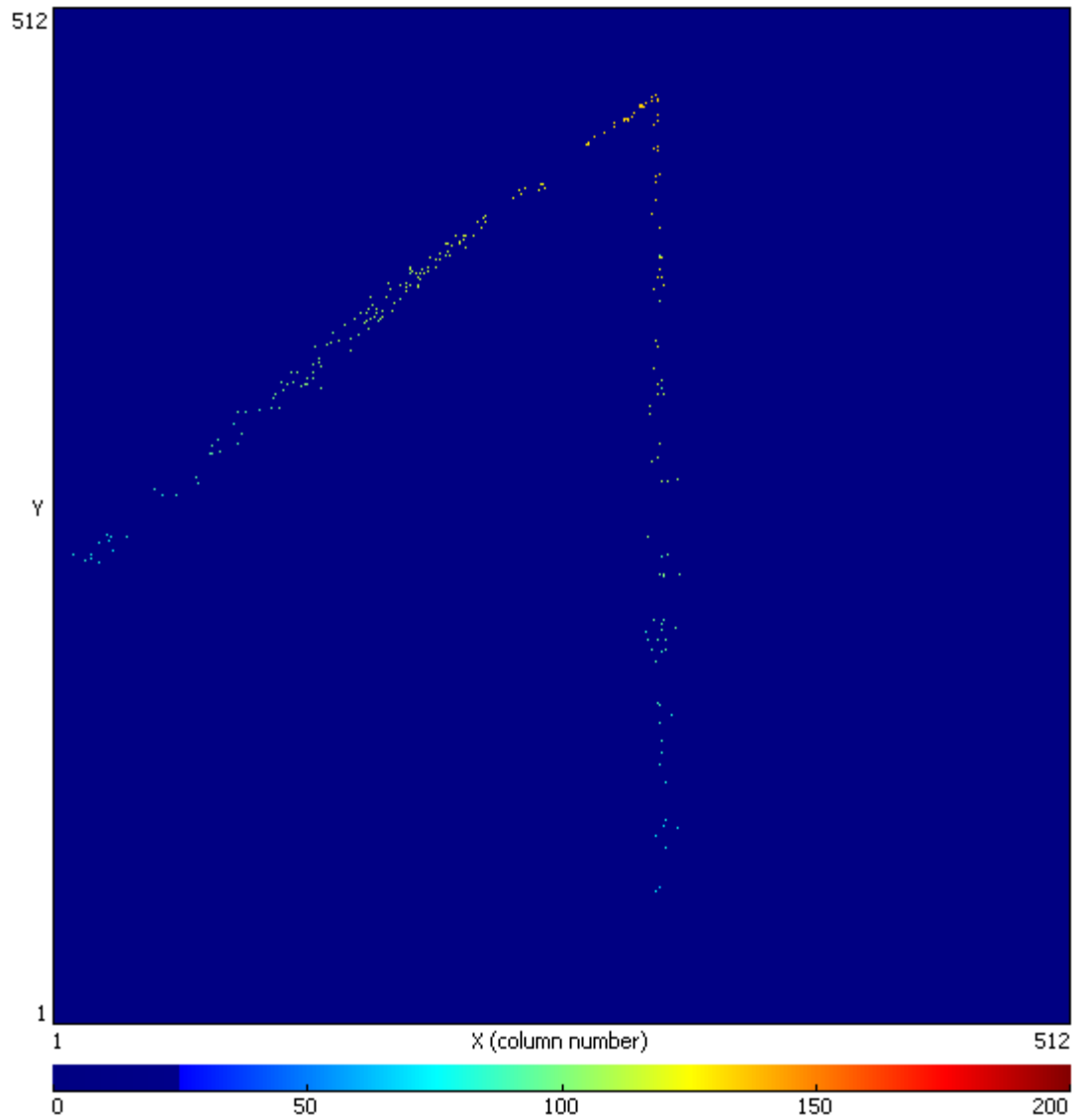
# Few tracks from ~3-day test at DESY with NIKHEF 4x Ingrid detector (March 2010)



A normal track



# Track backscattering from chip (=anode)



# Handshaked Pixelman operation

based on Uwe Renz Pixelman plugin

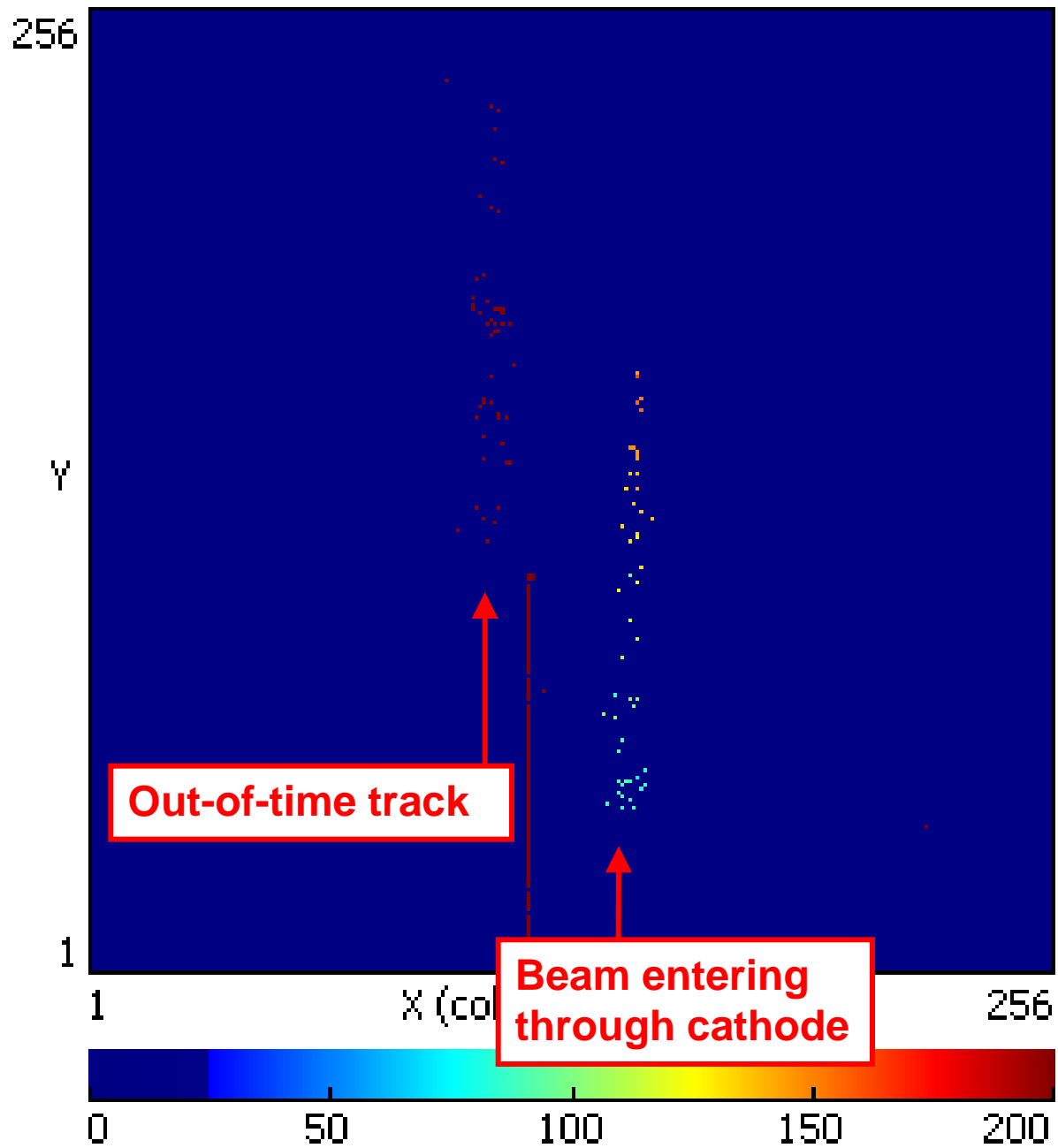
Work performed with Uwe Renz (and Martin Killenberg support) and with DESY summerstudent Bonnie Chow

Detector used is the (2009) “8 um” Ingrid

# Some events ...

- Handshaked mode
- Early shutter opening, so you will see “out-of-time” tracks
- He/iC<sub>4</sub>H<sub>10</sub> 80/20
- $E_{\text{drift}} = 450 \text{ V/cm}$
- $V_{\text{grid}} = 420 \text{ V}$





# Common data taking with Zeus MVD telescope on 8 Sept. 2010

- Using TLU for TRIGGER and BUSY synchronisation
- Writing of data using EUDAQ with Pixelman Timepix Data Producer plugin and Timepix Data Collector in EUDAQ computer
- Data transfer via TCP-IP
- ~ 4000 triggers written
- Possible problem still with “Endianness”
- Analysis awaiting

i r f u



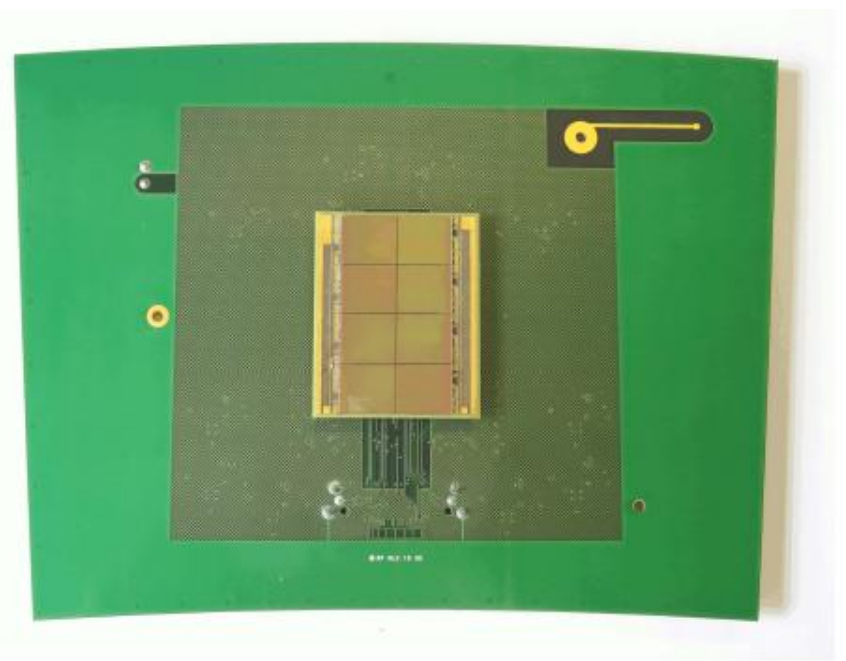
saclay

# Design and operation of an 8- TimePix chip TPC Endplate

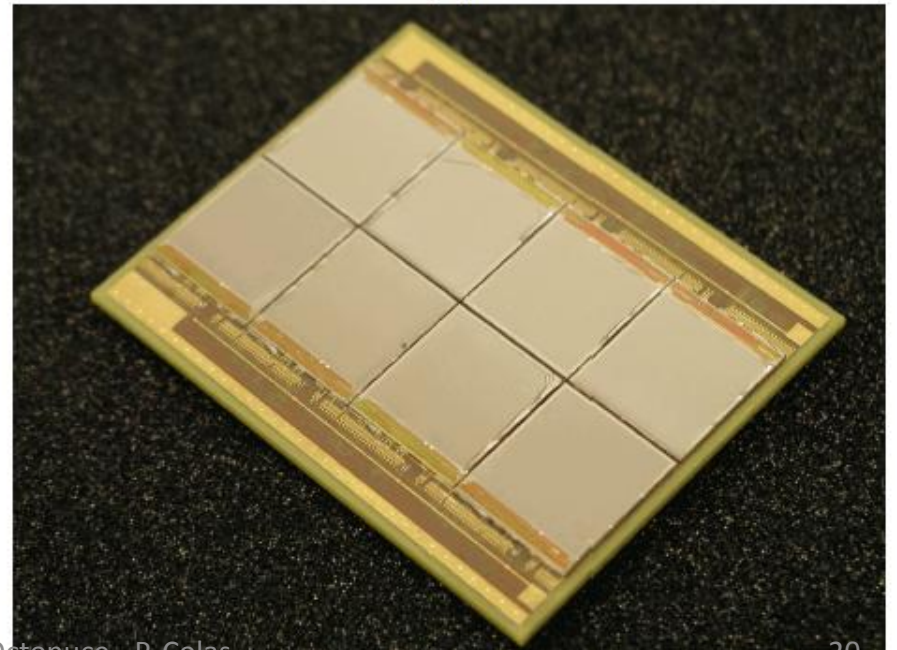
D. Attié, P. Colas, X. Coppolani, E. Delagnes,  
M. Lupberger, M. Riallot



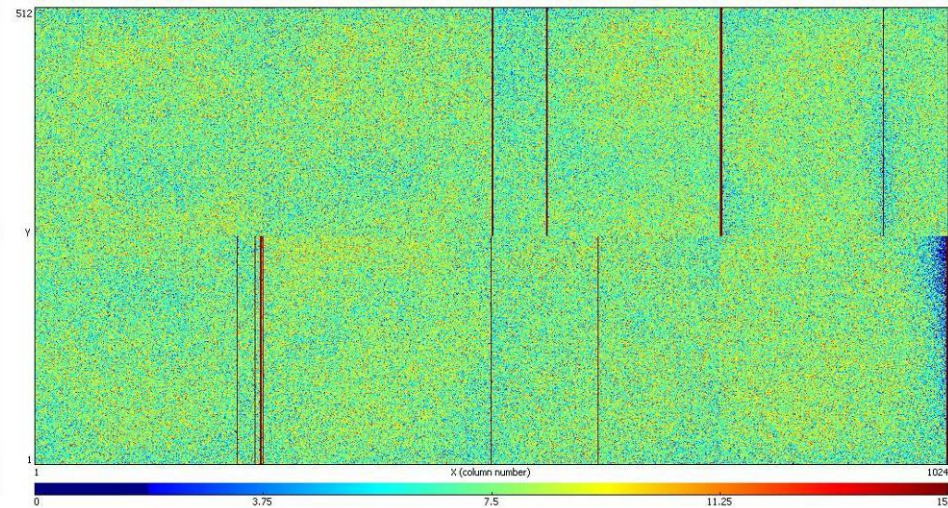
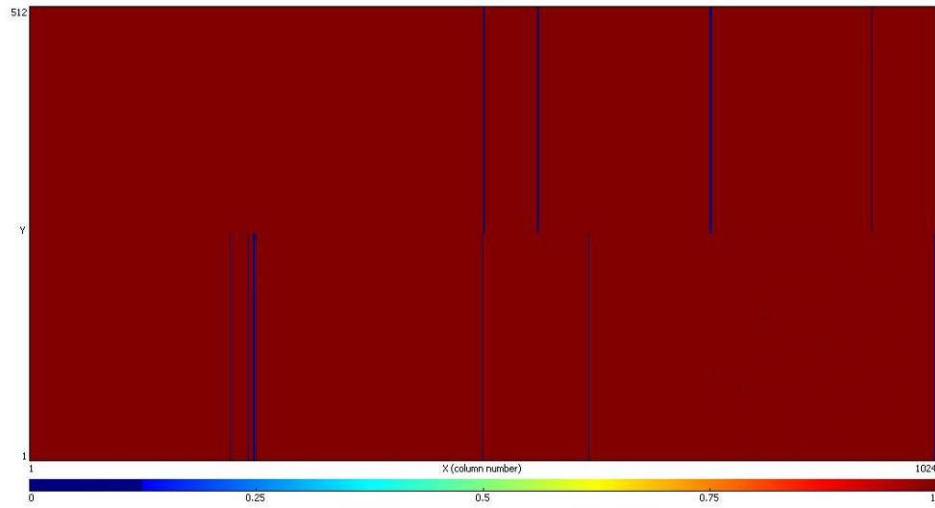
(1)



(2)

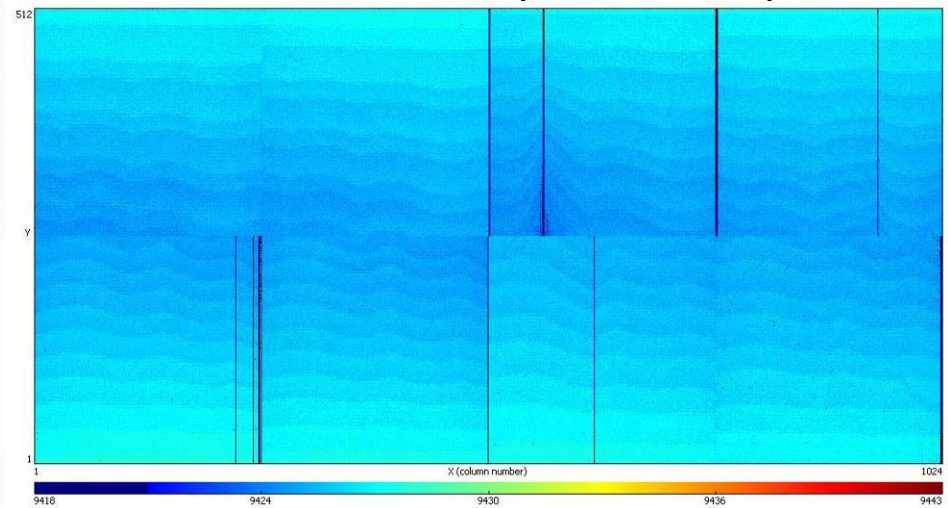
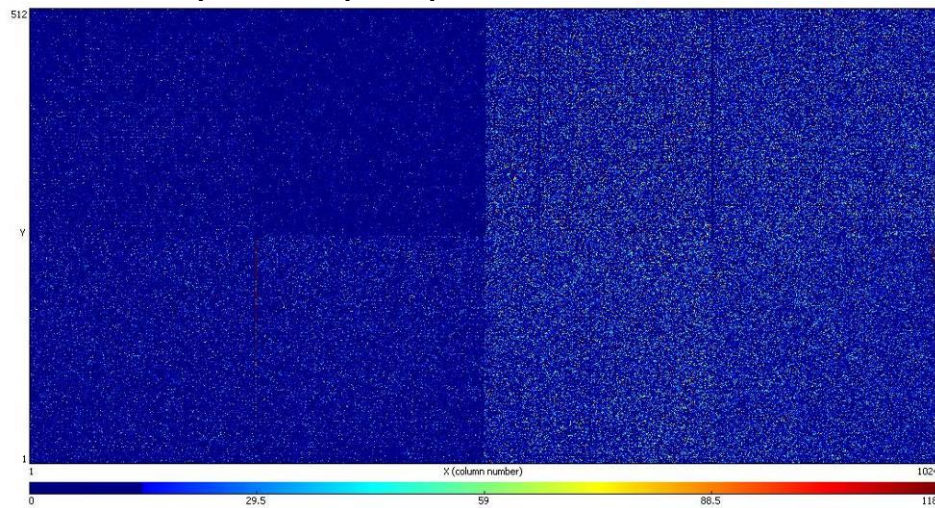


18.05.2010: all 8 chips detected on board and electronically tested  
Images from Pixelman



Mask map: 4352 pad pixels  $\Rightarrow$  519937 channels

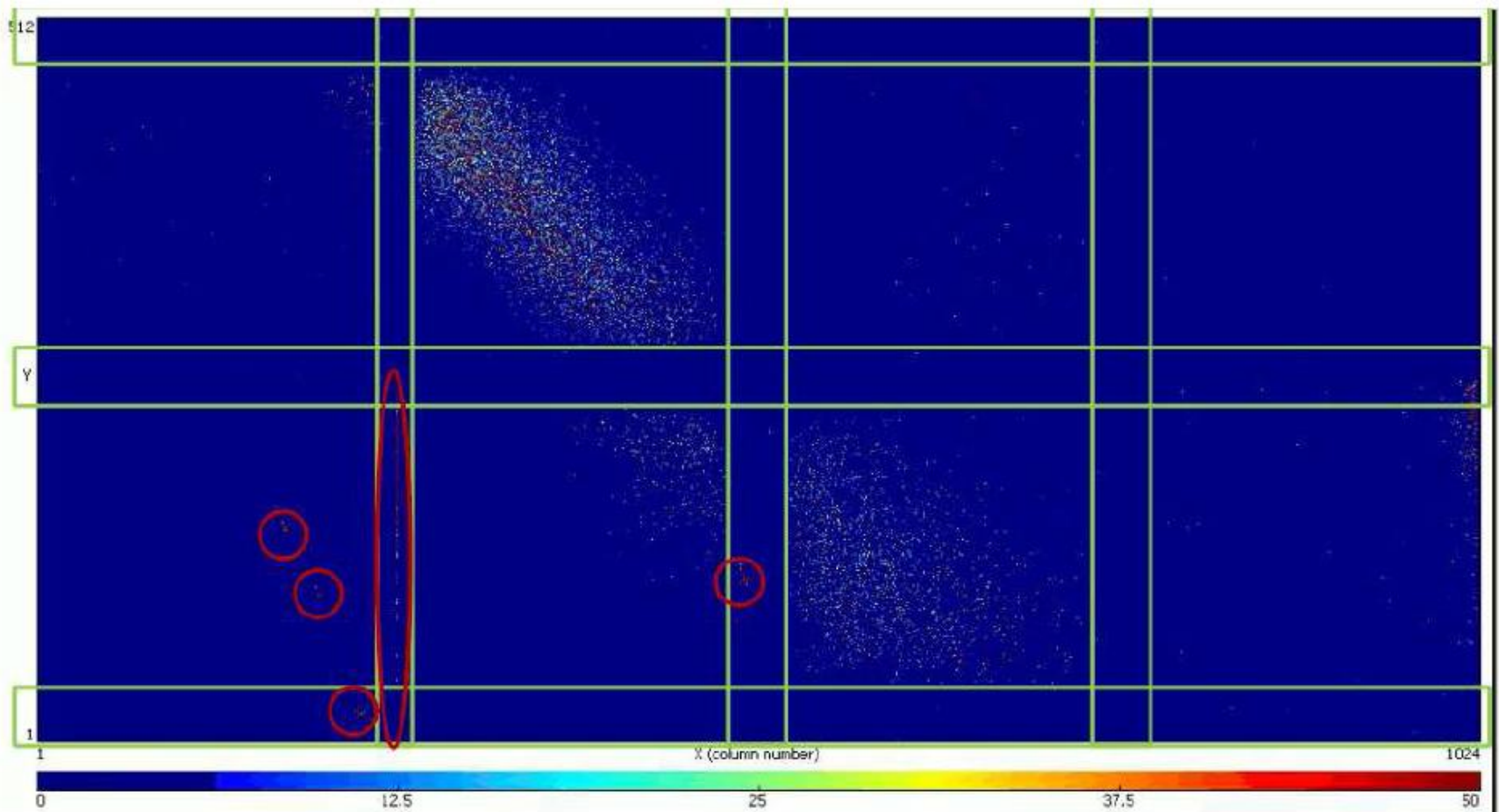
Threshold adjustment map



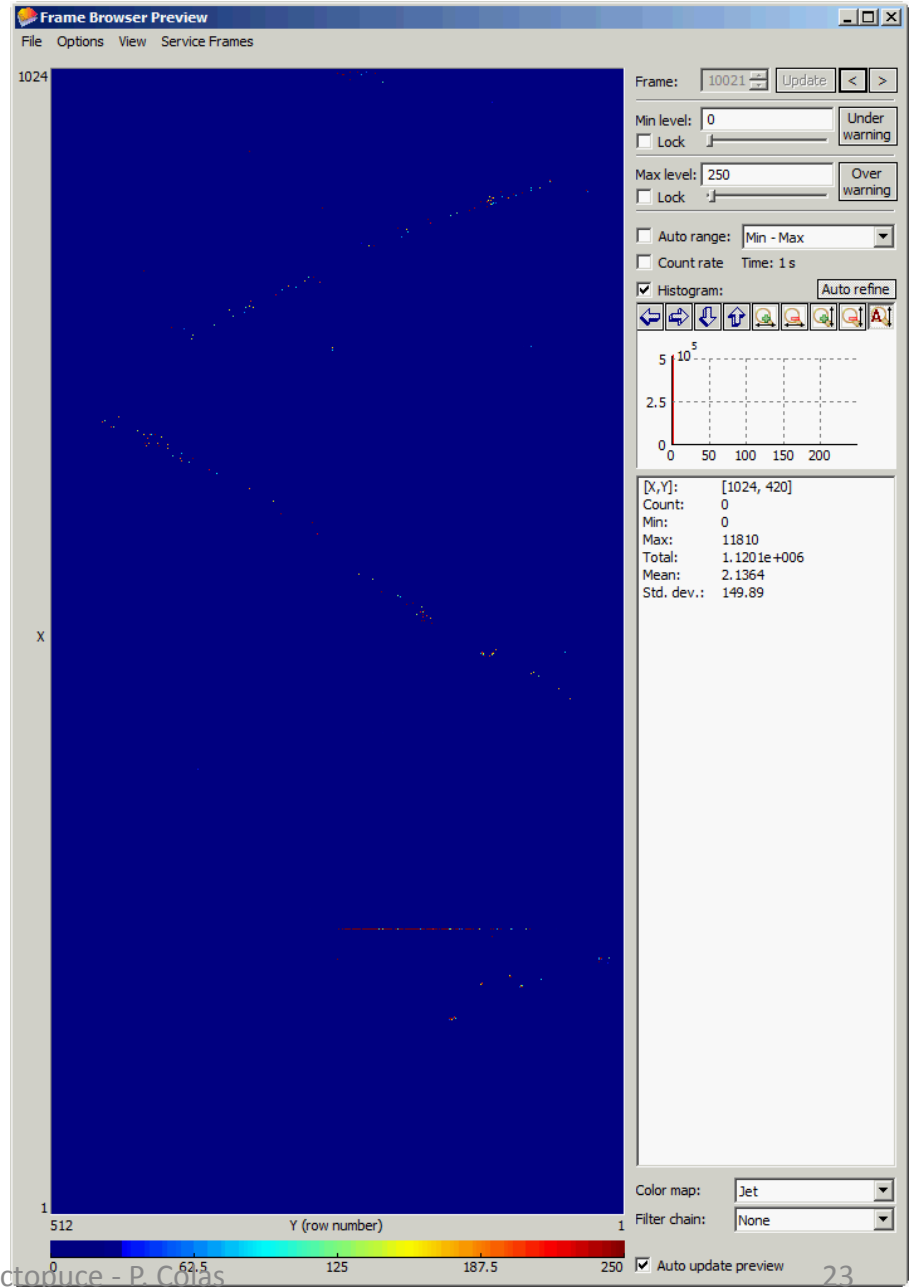
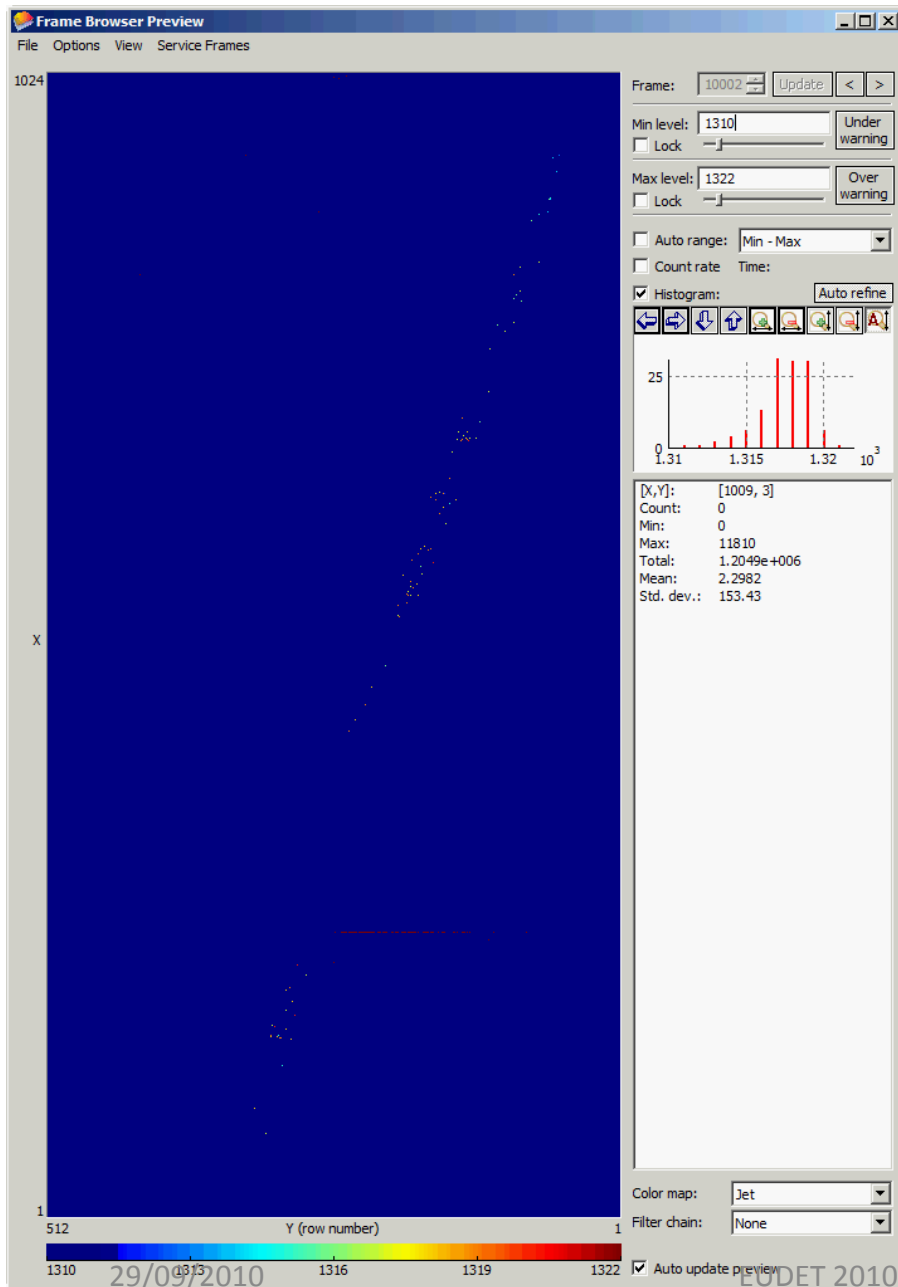
Noise (different threshold for chips to see them)

Test pulses in TIME mode

# An alpha particle in the octopuce with Ar+5%isobutane at 275 V



# Data taken in He + 20% isobutane at 375 V

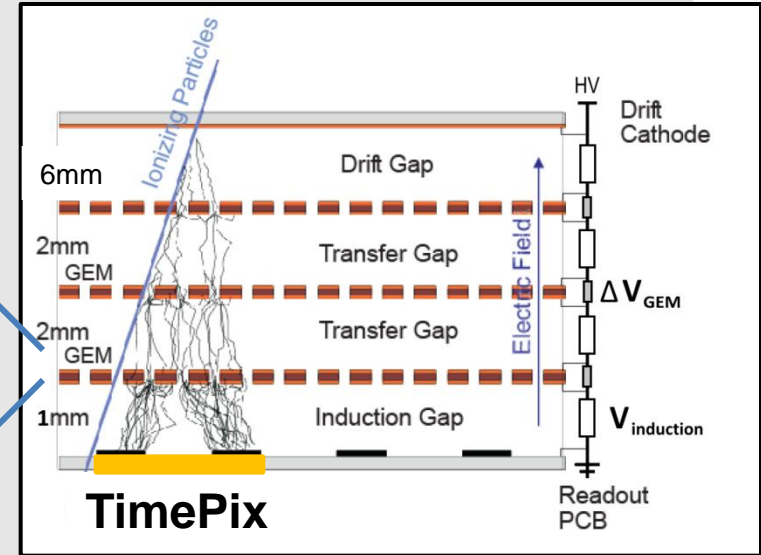
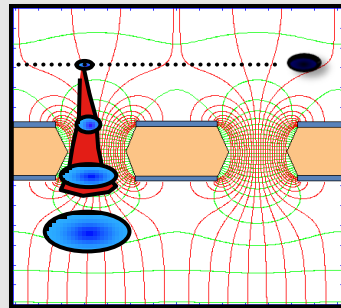
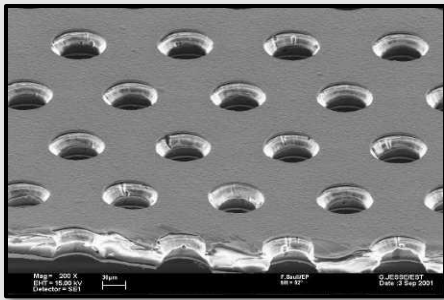


Some results presented at  
meetings earlier in 2010



# Test Setup

## GEM Setup

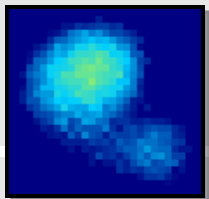


## GEM+TimePix

charge is spread over *several pixels* (>50)

Consequences

- few  $e^-$  per channel (strong diffusion effects within the GEM-stack)
- high gas gain necessary for detection of *MIPs*



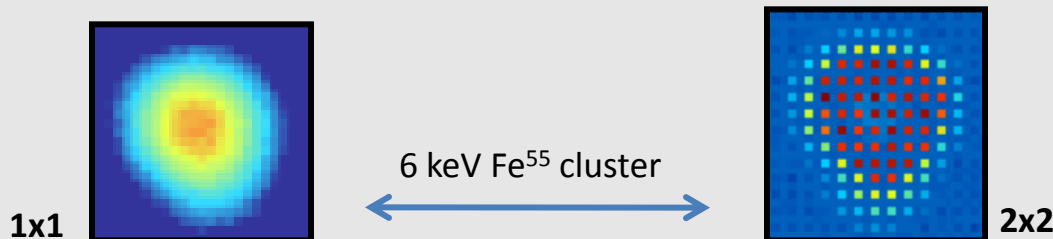
# Post Processed chips

## Postprocessed chips (IZM)

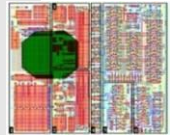
- **1x1**: metallization extended from  $\approx 20 \times 20 \mu\text{m}^2$  to  $\approx 50 \times 50 \mu\text{m}^2$
- **2x2**: 3 of 4 pixels passivated, then metalized pixel size  $105 \times 105 \mu\text{m}^2$

## Motivation: enlarged pixels

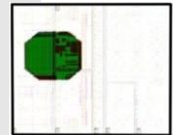
- more charge per pixel  
→ higher probability of detection
- less gas amplification needed → fewer positive ions
- optimization of spatial resolution vs. pixel size



TimePix  
(original)

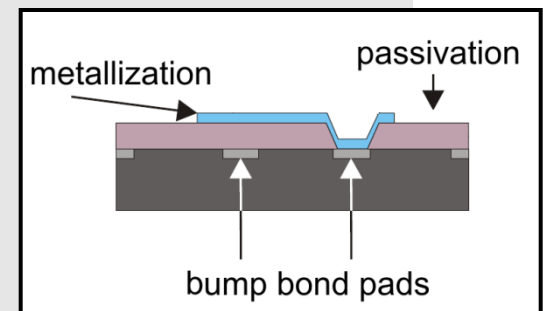


TimePix  
1x1



TimePix  
2x2

pixel input



profile of postprocessed pixels

# Gain studies and Crosstalk

## Setup

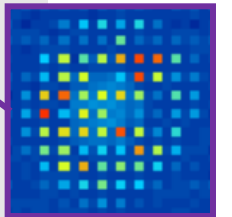
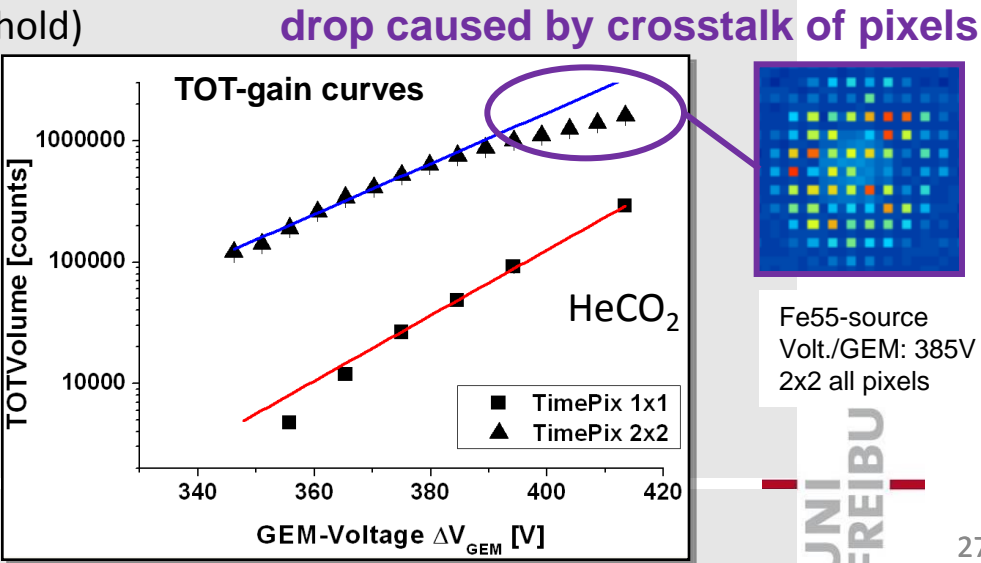
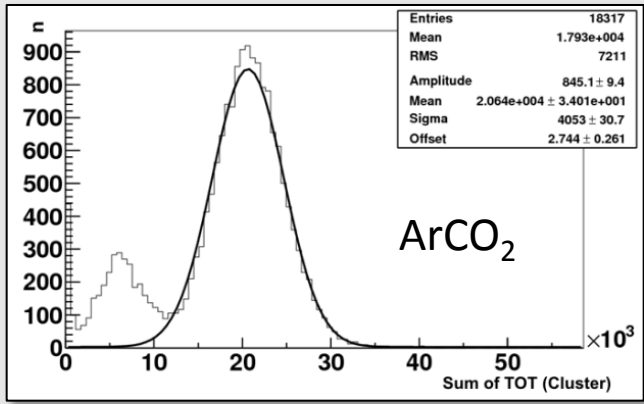
- gas: HeCO<sub>2</sub>/ Fe55 (6 keV photons)
- 1x1 and 2x2 with similar thresholds

## Procedure

- find clusters
- sum up the *TOT* values of the pixels (TOT - counts clock cycles above a chosen threshold)
- fit gauss (peak)
- take mean = *TOTVolume*

## Conclusion

with pixel enlargement:  
 → less gas gain needed



Fe55-source  
 Volt./GEM: 385V  
 2x2 all pixels

# Detector Module

Bonn + Freiburg

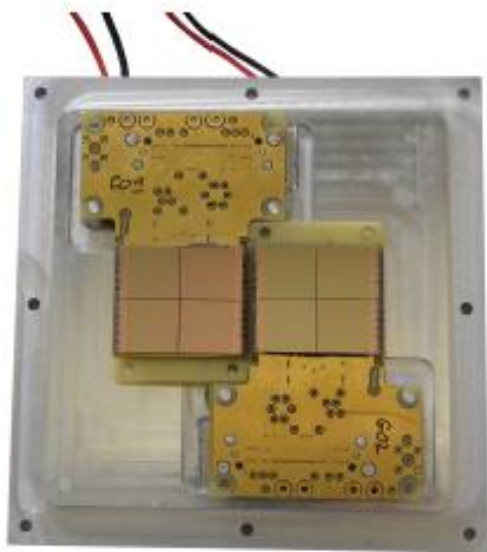


Gas Amplification Stage: stack of 3 GEMs

Readout: 8 Timepix chips + 2 MUROS

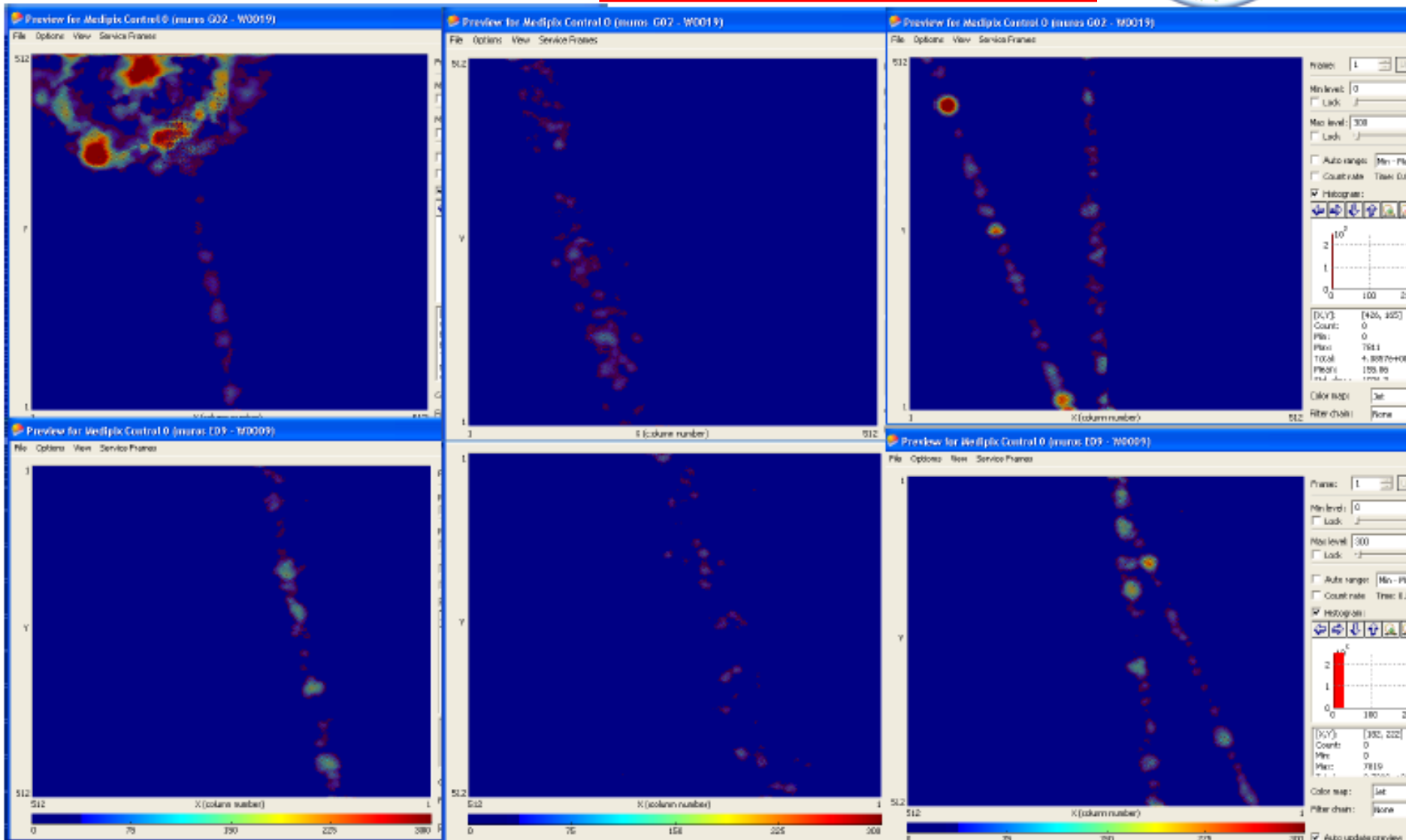
Gas Mixture: He:CO<sub>2</sub> 70:30 and Ar:CF<sub>4</sub>:iButan 95:3:2

A large set of data was taking varying the track inclination, particle momentum, drift distance, gas gain and magnetic field.



# Example Tracks

## Bonn + Freiburg

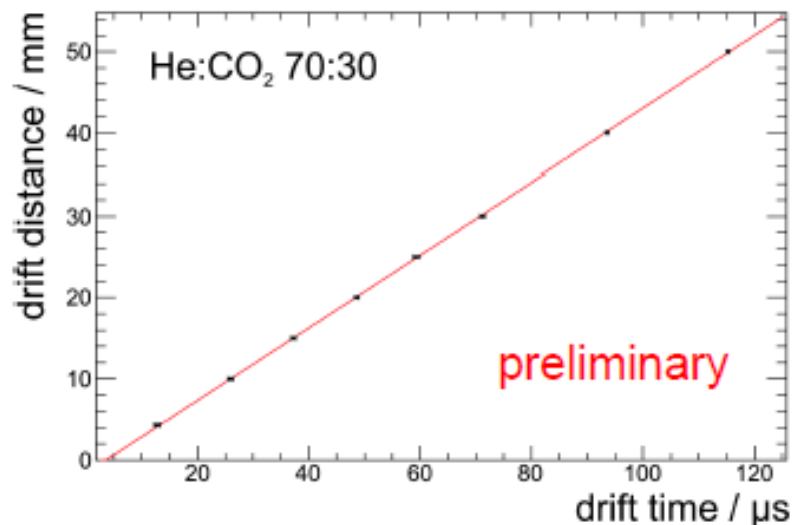


Drift Distance 10 cm

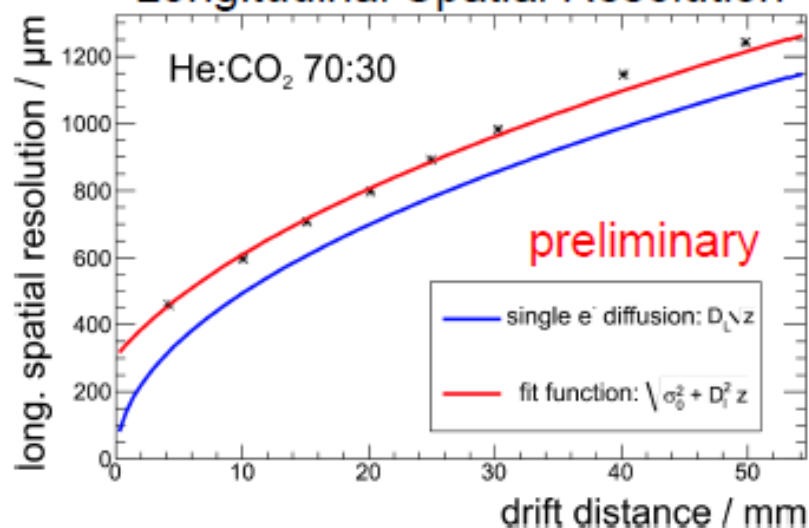
Drift Distance 50 cm

Drift Distance 4 cm 2

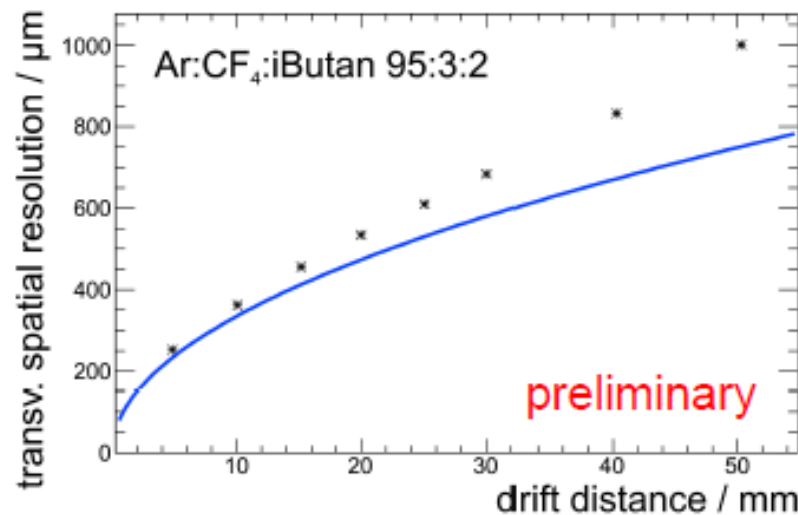
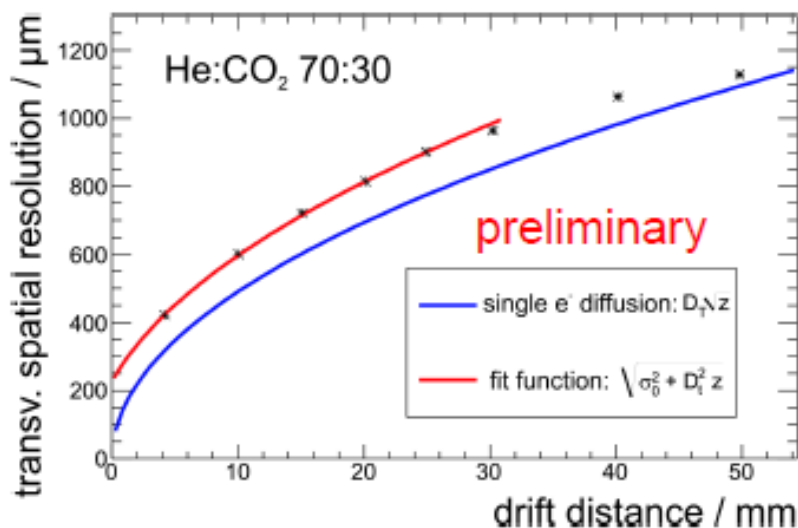
### Determination of Drift Velocity



### Longitudinal Spatial Resolution



### Transverse Spatial Resolution



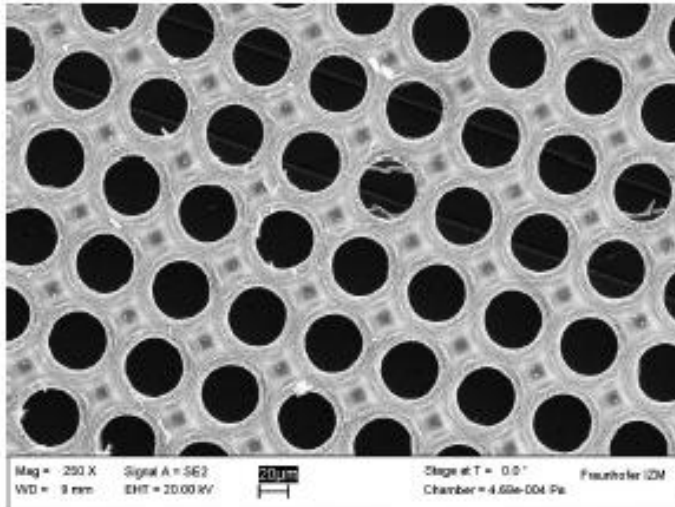


Detector was damaged after last run.

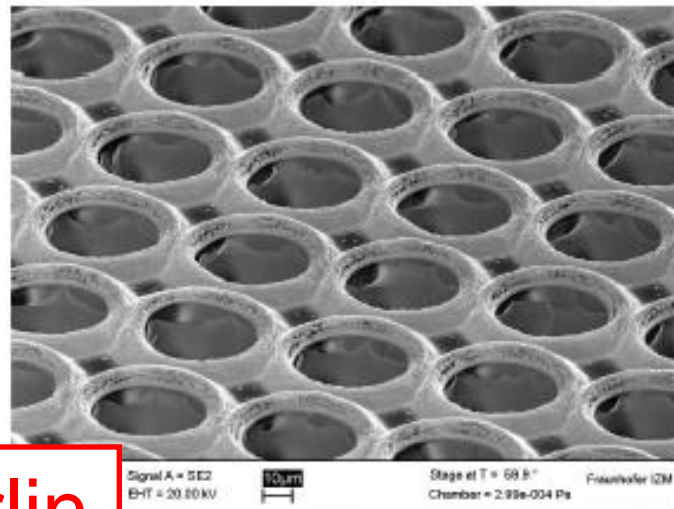
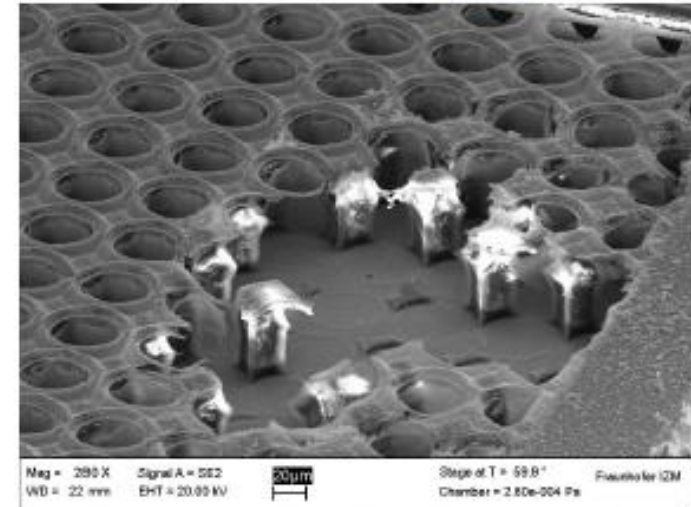
Repair work has been finished,  
the chips are now being calibrated,  
the detector will be reassembled soon and then shipped to DESY.

Another test beam campaign is under consideration to benefit  
from the improved LP setup.  
(i.e. get rid of magnetic field inhomogeneities)

## GEMGrid



Pitch of the holes is 55  $\mu\text{m}$ .



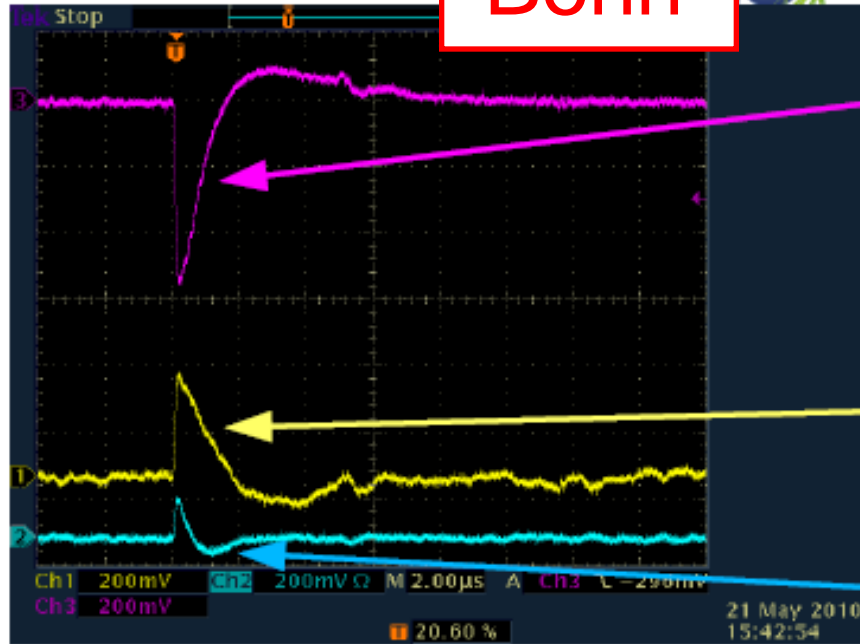
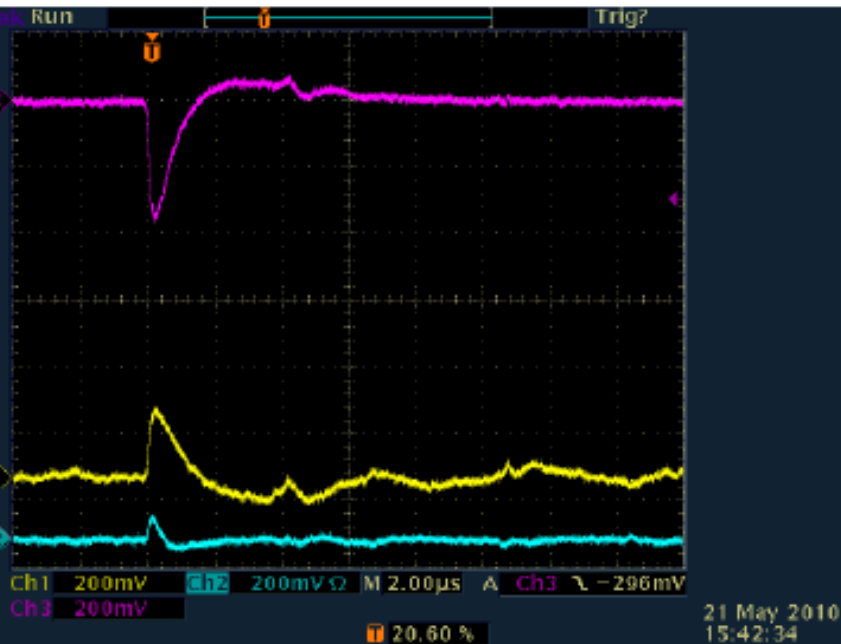
Small walls (2-3  $\mu\text{m}$ )  
around the holes.



# First Signals with $^{90}\text{Sr}$ source



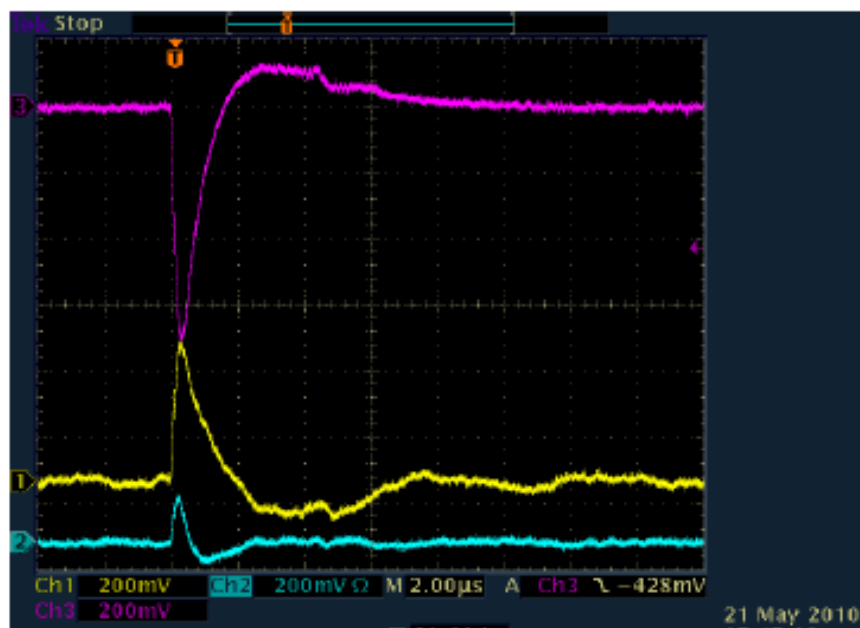
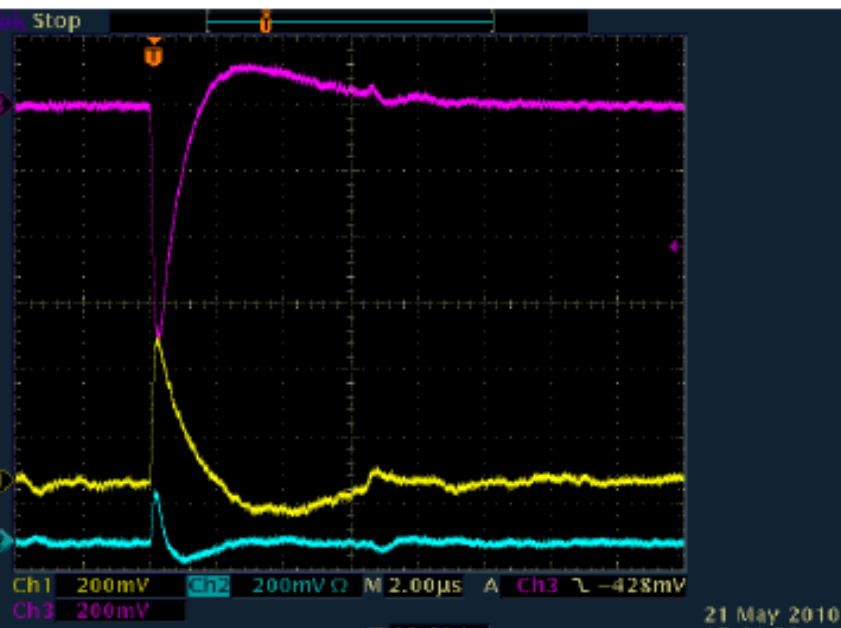
Bonn



signal on grid

signal on pad

signal on ring

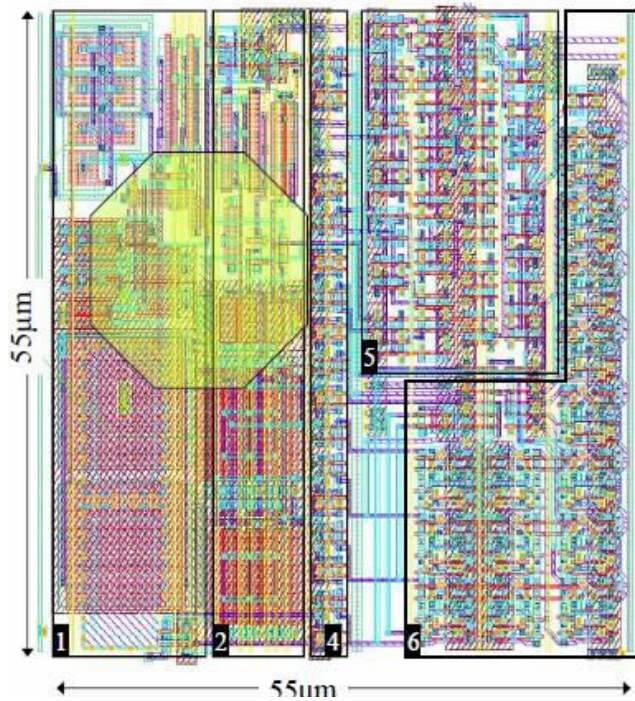


Rate highly correlated with rad source!

# Summary of highlights

(the “deliverables”)

## Timepix layout



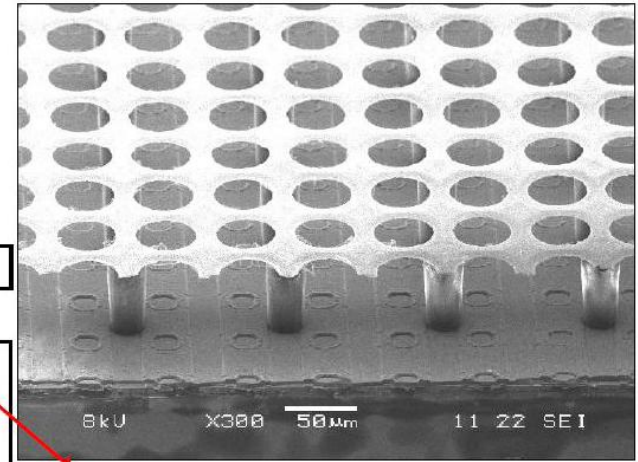
## Full post-processing of a TimePix

· Timepix chip + SiProt + Ingrid:

Timepix chip:  
 • 256x256 pixels  
 • pixel: 55x55 μm<sup>2</sup>  
 • active surface:  
 14x14 mm<sup>2</sup>

MESA+: Ingrid

IMT Neuchatel:  
 15 or 20 μm highly  
 resistive aSi:H  
 protection layer



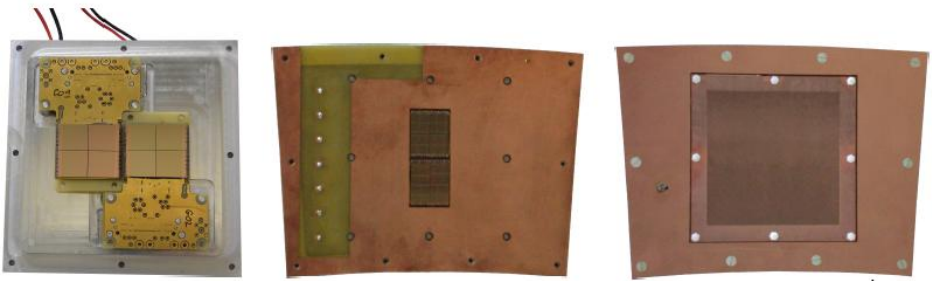
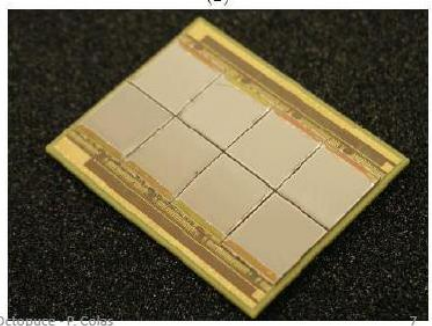
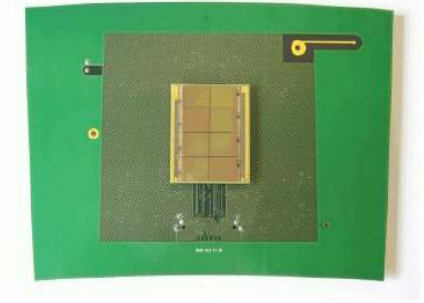
Now also Si<sub>3</sub>N<sub>4</sub> protection layers (7 μm)

## Detector Module



Gas Amplification Stage: stack of 3 GEMs  
Readout: 8 Timepix chips + 2 MUROS  
Gas Mixture: He:CO<sub>2</sub> 70:30 and Ar:CF<sub>4</sub>:iButan 95:3:2

A large set of data was taking varying the track inclination,  
 particle momentum, drift distance, gas gain and magnetic field.



# Conclusions

- EUDET-SITPC final infrastructure available for 3-GEM + 8 Timepix chips. New test at LP foreseen in fall 2010.
- LP module with 8 Timepix+Ingrid chips produced. Some HV problems with Ar mixtures. Operational with He/iC<sub>4</sub>H<sub>10</sub>. Test at LP late(?) 2010.
- Quad-Ingrid detector for standalone tests having readout problems; being investigated.
- All (or most) EUDET money is spent; some groups 'overspent' own contribution.
- Longer term: working on larger systems of 64 and 119 chips for Ingrids and GEMs or GEMGrids.
- Despite some problems, consider JRA2/SITPC very successful.